



85-PGM11007-10H Information

Heisener.com

Part Number 85-PGM11007-10H
Manufacturer Aries Electronics

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN SOCKET PGA GOLD

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









85-PGM11007-10H Specifications

Manufacturer Part Number	85-PGM11007-10H
Manufacturer	Aries Electronics
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	PGM
Type	PGA
Number of Positions or Pins (Grid)	-
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	10μin (0.25μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	-
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200μin (5.08μm)
Contact Material - Post	Brass
Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled
Operating Temperature	-55°C ~ 105°C
	Report errors?

85-PGM11007-10H Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

85-PGM11007-10H Payment Methods





















85-PGM11007-10H Shipping Methods













If you have any question about 85-PGM11007-10H, please do not hesitate to contact us!

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